## ASSP For Power Supply Applications

## Power Management Switch

## MB3802

## ■ DESCRIPTION

The MB3802 is a power management switch incorporating two switch circuits with extremely low ON resistance.
NO diode is required because the switch block is configured with an N-ch MOS to prevent reverse current at switch OFF.

The MB3802 starts at a very low voltage (typical ViN $>2.2 \mathrm{~V}$ ) and a stable ON resistance is obtained irrespective of the switching voltage because the internal DC/DC converter applies the optimum voltage for the N-ch MOS gate at switch ON.
Moreover, the load-side capacitor is discharged at switch OFF, and the power supply for various power supply systems is switched efficiently.

## - FEATURES

- Extremely low ON resistance:

Ron $=0.12 \Omega$ (typical)
Ron $=0.06 \Omega$ (typical at parallel connection)

- Reverse current protection at load side at switch OFF
- Operation start at low input voltage: Vin > 2.2 V (typical)
- Low power consumption

At switch OFF: lin (input voltage) $=0 \mu \mathrm{~A}, \mathrm{VIN}=0 \mathrm{~V}$
At switch ON: $\mathrm{lin}=230 \mu \mathrm{~A}, \mathrm{Vin}=5 \mathrm{~V}$

- Load discharge function
- External control of ON/OFF time
- Break-before-make operation


## PACKAGE

16-pin plastic SOP
(FPT-16P-M04)

## PIN ASSIGNMENT



## PIN DESCRIPTION (SCSI Interface)

| Pin No. | Pin symbol | Description |
| :---: | :---: | :---: |
| 16 | VINA | These pins switch ON at High level and OFF at Low level. They serve as power-supply pins for the DC/DC converter to generate the switch gate voltage. |
| 9 | VINB |  |
| 3, 4 | SWINA | Switch Input pins: Two common pins are assigned to SWINA and SWINb. They serve as power-supply pins for the switch-OFF circuit which starts at 1.5 V min. |
| 5, 6 | SWINB |  |
| 13, 14 | SWOUTA | Switch output pins: Two common pins are assigned to SWOUTA and SWOUTb. When DCGA and DCGB are High level, the loaddischarge circuit starts discharge via these pins. |
| 11, 12 | SWOUTb |  |
| 2 | DCGA | SWOUTA/SWOUTb-side discharge control pins: These pins are used to discharge from the load-side capacitor at switch OFF. Connect them to GND when discharge is not required. |
| 7 | DCGb |  |
| 15 | DLYA | Switch-ON/OFF control pins: The ON/OFF time can be delayed by connecting an external capacitor. Both times are delayed about three fold by installing a $500-\mathrm{pF}$ capacitor between these pins and GND. Leave these pins open when they are not used. 10 V may be generated when these pins are open. To keep these pins at high impedance, take care to mount the device so that no current leaks (less than $0.1 \mu \mathrm{~A}$ ). |
| 10 | DLYв |  |
| 1 | GNDA | Ground pins for input threshold reference voltage and load discharge: When two switching circuits are used, ground both GND pins. |
| 8 | GNDв |  |

## BLOCK DIAGRAM AND EXTERNAL CONNECTIONS



Note: The MB3802 incorporates two switch blocks as shown above. However, GND is common to both blocks.

## BLOCK DESCRIPTION

The MB3802 is a one-way switching IC with the SWIN and SWOUT pins serving respectively for input and output. When Vin exceeds 2.2 V , the Comp. starts driving the DC/DC converter to switch the N -ch MOS and applies the optimum voltage for the switch gate.
The DC/DC converter boosts the Vin voltage.
When VIN is below 2.1 V , the Comp. stops the DC/DC converter, starts the switch-OFF circuit, and discharges the voltage from the switch gate to GND. The switch-OFF circuit is powered from the SWin and consumes $0.4 \mu \mathrm{~A}$ at 5 V .
Since the N-ch MOS back gate is connected to GND, switch-OFF reverse current is prevented irrespective of the High level state between SWIN and SWout. Note, however, that turning the VIN pin on/off with 1.5 V or less applied to the SWIN pin may cause reverse current to flow because the switch-off circuit does not work then. For the method of compensating for the operation of the switch-off circuit, see section "■APPLICATIONS 7.Lowside Switch."
The load discharge circuit installed between SWout and GND is powered by the DCG pin, and discharges the load-side capacitor at switch OFF. When it is not necessary to discharge the load, connect the DCG pin to GND. The DLY pins are for connection to an external capacitor to delay the switch-ON/OFF time. The surge current at the load side is cut at power-on by controlling the switch-ON time. The switch-ON time depends on the boot time of the DC/DC converter. Consequently, when the VIN level is high and the SWin level is low, the switch-ON time is small; when the SWin level is high, the switch-OFF time is small.

## MB3802

ABSOLUTE MAXIMUM RATING

| Parameter | Symbol | Condition | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Input Voltage | Vin | - | -0.3 to 7.0 | V |
| Switching voltage | Vsw | At switch OFF | -0.3 to 7.0 | V |
|  |  | At switch ON | -0.3 to 7.0 |  |
| Switching current | Isw | At switch-ON peak | 3.6 | A |
| Permissible loss | PD | $\mathrm{Ta} \leq+75^{\circ} \mathrm{C}$ | 290 | mW |
| Storage Temperature | Tsta | - | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Conditions | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typical | Max. |  |
| Input voltage | Vin | - | 0 | - | 6.0 | V |
| Switching level | Vswin | At switch ON | 0 | - | 6.0 | V |
|  |  | At switch OFF | 0 | - | 6.0 |  |
| Switching current | Isw | At switch on (for single switch) | - | - | 1.2 | A |
| Gate-pin connection capacitance | Co | - | - | - | 10 | nF |
| Gate-pin mounting leak current | IdLy | - | -0.1 | - | 0.1 | $\mu \mathrm{A}$ |
| Input voltage to load discharge circuit | Vocg | $\mathrm{VIN}=3 \mathrm{~V}, 5 \mathrm{~V}$ | 2.5 | - | 6.0 | V |
| Operating temperature | Top | - | -40 | - | +7.5 | ${ }^{\circ} \mathrm{C}$ |

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## ELECTRICAL CHARACTERISTICS

## 1. DC Characteristics

| Parameter | Symbol | Condition | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| Input current | lin1 | $\mathrm{VIN}=0 \mathrm{~V}$ | - | 0 | - | $\mu \mathrm{A}$ |
|  | lin2 | $\mathrm{VIN}=3 \mathrm{~V}$ | - | 100 | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{VIN}=5 \mathrm{~V}$ | - | 230 | 460 | $\mu \mathrm{A}$ |
| Swiching resistance | Ron1 | $\begin{aligned} & \mathrm{V} \operatorname{IN}=3 \mathrm{~V}, \mathrm{Isw}=0.5 \mathrm{~A}, \\ & \mathrm{Vswin}=3 \mathrm{~V} \end{aligned}$ | - | 120 | 160 | $\mathrm{m} \Omega$ |
|  | Ron2 | $\begin{aligned} & \mathrm{VIN}=5 \mathrm{~V}, \mathrm{Isw}=0.5 \mathrm{~A}, \\ & \mathrm{Vswin}=3 \mathrm{~V} \end{aligned}$ | - | 130 | 175 | $\mathrm{m} \Omega$ |
| Switch-OFF leak current | IL | $\mathrm{VIn}=0 \mathrm{~V}, \mathrm{Vswin}=6 \mathrm{~V}$ | - | 0.5 | 2.0 | $\mu \mathrm{A}$ |
| Input threshold voltage | $\mathrm{V}_{\text {TH1 }}$ | At switch ON | 2.0 | 2.2 | 2.4 | V |
|  | Vth2 | At switch OFF | 1.9 | 2.1 | 2.3 | V |
| Input hysteresis width | VHYS | - | 50 | 100 | - | mV |
| Switch resistance | Ron | $\begin{aligned} & \mathrm{Vin}=3 \mathrm{~V}, 5 \mathrm{~V}, \mathrm{Isw}=0.5 \mathrm{~A} \\ & \mathrm{Ta}=-40^{\circ} \mathrm{C} \text { to }+75^{\circ} \mathrm{C} \end{aligned}$ | - | - | 210 | $\mathrm{m} \Omega$ |
| Switch charge resistance | Rocg1 | Vswout = 3 V , VdcG $=3 \mathrm{~V}$ | - | 750 | 1500 | $\Omega$ |
|  | Rdcg2 | Vswout $=5 \mathrm{~V}, \mathrm{VdcG}=5 \mathrm{~V}$ | - | 500 | 1000 | $\Omega$ |
| Input voltage to switch charge circuit | Idcg | V dcG $=5 \mathrm{~V}$ | - | 0 | 2 | $\mu \mathrm{A}$ |

## 2. AC Characteristics

| Parameter | Symbol | Condition | Ratings |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| Switch-ON time | ton1 | $\mathrm{VIN}=0 \mathrm{~V} \rightarrow 3 \mathrm{~V}, \mathrm{Vswin}=3 \mathrm{~V}$ | 20 | 300 | 900 | $\mu \mathrm{s}$ |
|  | ton2 | $\mathrm{VIN}=0 \mathrm{~V} \rightarrow 5 \mathrm{~V}, \mathrm{Vswin}=5 \mathrm{~V}$ | 20 | 150 | 450 | $\mu \mathrm{s}$ |
| Switch OFF time | toff1 | $\mathrm{VIN}=3 \mathrm{~V} \rightarrow 0 \mathrm{~V}, \mathrm{Vswin}=3 \mathrm{~V}$ | 5 | 60 | 180 | $\mu \mathrm{s}$ |
|  | toff2 | $\mathrm{VIN}=5 \mathrm{~V} \rightarrow 0 \mathrm{~V}, \mathrm{Vswin}=5 \mathrm{~V}$ | 5 | 30 | 150 | $\mu \mathrm{s}$ |
| Switch ON/OFF time lag | thYS1 | $\mathrm{VIN}=3 \mathrm{~V} / 0 \mathrm{~V}$, Vswin $=3 \mathrm{~V}$ | 10 | 240 | 720 | $\mu \mathrm{s}$ |
|  | thYs2 | $\mathrm{VIN}=5 \mathrm{~V} / 0 \mathrm{~V}, \mathrm{Vswin}=5 \mathrm{~V}$ | 10 | 120 | 300 | $\mu \mathrm{s}$ |

## MB3802

## AC CHARACTERISTIC TEST DIAGRAMS

## 1. Test Condition



## 2. Switch-ON/OFF Timing Chart



Note: The rise/fall times ( $10 \% / 90 \%$ ) of Vin are both less than $1 \mu \mathrm{~s}$.

## APPLICATIONS

## 1. Separate Use of Two Switching Circuits



Notes:

1. The two power supplies VsA andVsb can be used separated by controlling the voltages VINA and VINb.
2. Connect the DCD pin to GND when it is not used.

## 2. Switching Two Power Supplies



Note: When using different power supplies for a single load, control them by connecting an external capacitor so that both switches are not ON at the same time.

## MB3802

## 3. Switching Two Loads



Note: Make this connection to control two different loads separately for a single power supply.

## 4. Connecting Serial Switches



Note: Make this connection to supply power from Vs to load B via load A.

## 5. Connecting Parallel Switches



Note: Connect the circuits A and B in parallel to produce a low ON resistance (Ron $=0.06 \Omega$ ). In this case, connect the DLYA and DLYB pins in common to give synchronous ON/OFF between both switches.

## 6. $\mathbf{2 5 \%}$ ON Resistance



Notes:

1. Make this connection to produce an ON resistance that is much lower than the above connection.

Also, connect the DLY pins in common.
2. Consider the difference between the ON resistances and the switch-ON/OFF times between two devices (MB3802) and insure that load control is not offset at one device.

## MB3802

## 7. Low-side Switch



|  | $\mathrm{V}_{\mathbb{N}}=3 \mathrm{~V}, \mathrm{Vs}=3 \mathrm{~V}$ | $\mathrm{~V} \mathbb{N}=5 \mathrm{~V}, \mathrm{Vs}=5 \mathrm{~V}$ |
| :--- | :---: | :---: |
| Switch-ON time | $80 \mu \mathrm{~s}$ | $45 \mu \mathrm{~s}$ |
| Switch-OFF time | 5.0 ms | 3.5 ms |

$R_{A}$ and $R_{B}=10 \mathrm{M} \Omega$

Notes:

1. Make this connection to control the switch ON/OFF at the lower load side.
2. To assist the switch-OFF circuit operation driven by the SWIN power supply, connect high resistances ( $R_{A}$ and $R_{B}=5$ to $10 \mathrm{M} \Omega$ ) to the DLY pins without overloading the DC/DC converter.
3. At this connection, the switch-OFF time is longer than the switch-ON time.

## TYPICAL PERFORMANCE CHARACTERISTICS



## MB3802


(Continued)


## MB3802

PACKAGE DIMENSIONS
16-pin plastic FTP
(FTP-16P-M04)

© 1994 FUJTSU LIMTED F16012S-4C-4
Dimensions in mm (inch)

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